

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	(circuit and board and electrical and contact and substrate and carrier and layer and conductor and track and transversely and mounting and surface and via and filling and material and heat and dissipation). clm. and "257".clas.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/11/19 10:26
S1	1279	((Heyen near (Johann J)) (Jacob near (Arne A))).in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/11/19 10:22
S2	376209	"257".clas.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/02 11:54
S3	11	S1 and S2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/02 12:58
S4	6	((("5650592") or ("5570502") or ("5526867"))).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/18 08:47
S5	2	("5983974").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/18 08:49
S6	2	"20030128080"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 09:21
S7	0	WO-199914806-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 09:22

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S8	2	WO-9914806-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 09:59
S9	27409	(257/678,684-687,690-693,698,700, 701,703-707,723-725,728,778, 787-789,795).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/18 10:01
S10	12621	(438/106-110,118-127).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/18 10:01
S11	37189	S9 S10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 10:02
S12	2218	ltcc ("low temperature cofired ceramic")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 10:03
S13	20522	mcm ("multichip module")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 10:03
S14	26012	anisotropic near5 (paste film adhesive)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 10:04
S15	1	S11 and S12 and S13 and S14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 10:44

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S16	36633	flip adj chip	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 10:06
S17	0	S12 and S13 and S14 and S16	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 10:53
S18	9	S12 and S14 and S16	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 10:45
S19	4	S12 and S13 and S14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 10:54
S20	230	S16 and S13 and S14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 10:54
S21	10	(US-20010036711-\$ or US-20020132463-\$ or US-20020158318-\$ or US-20030071350-\$ or US-20030128080-\$).did. or (US-5729435-\$ or US-5983974-\$ or US-6100593-\$ or US-6140144-\$ or US-6764881-\$).did.	US-PGPUB; USPAT	OR	ON	2007/04/18 13:05
S22	26012	anisotropic near5 (paste film adhesive)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 13:05
S23	8	S21 and S22	US-PGPUB; USPAT	OR	ON	2007/04/18 13:05

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S24	20522	mcm ("multichip module")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 14:22
S25	36633	flip adj chip	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 14:22
S26	230	S25 and S24 and S22	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 14:22
S27	81	S26 and cavity	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 14:54
S28	2	S26 and gas adj atmosphere	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 14:57
S29	27409	(257/678,684-687,690-693,698,700, 701,703-707,723-725,728,778, 787-789,795).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/18 14:57
S30	12621	(438/106-110,118-127).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/04/18 14:57
S31	37189	S29 S30	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 14:57

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S32	281	S31 and gas adj atmosphere	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 15:39
S33	9	S32 and S24	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 14:58
S34	0	S26 and planar adj antenna	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 15:39
S35	7	S31 and planar adj antenna	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/04/18 15:39